
International Symposium on Functional Diversification of Semiconductor Electronics 3 (More-Than-Moore 3)

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Table of Contents

Preface *iii*

**Chapter 1
Sensors and Connectivity**

(Invited) Pixel-Parallel CMOS Image Sensors with 16-Bit A/D Converters Developed
by 3-D Integration of SOI Layers with Au/SiO₂ Hybrid Bonding 3
*M. Goto, K. Hagiwara, Y. Honda, M. Nanba, Y. Iguchi, T. Saraya, M. Kobayashi,
E. Higurashi, H. Toshiyoshi, T. Hiramoto*

(Invited) A 1-mG MEMS Sensor 7
D. Yamane, T. Konishi, H. Toshiyoshi, K. Masu, K. Machida

Light Sensing of a-Si:H *Pin* Diode - Wavelength and Intensity Effects 15
K. Kim, Y. Kuo

Electrochemical Characterization of Synthetic Hybrid DNA Molecular Wires 21
*A. Golkar Narenji, N. Goshi, M. Coste, D. Burns, R. Lee, K. Ngo, B. Purse,
S. Kassegne*

**Chapter 2
Materials and Fabrication**

(Invited) Fabrication of Implantable Glucose Fuel Cells on Silicon Wafers 31
R. Cabrera, I. Weaver, A. Banerjee, R. Sarpeshkar, T. Thorsen

(Invited) More Than Moore Applications with Thin-Film-Transistors Array Substrates 39
from Liquid Cristal Display: New Devices for Biological Cells Analyses
A. Tixier-Mita, S. Ihida, G. A. Cathcart, F. A. Shaik, H. Toshiyoshi

Chapter 3 Emerging Memory

(Invited) Comprehensive Assessment of Oxide Memristors As Post-CMOS Memory and Logic Devices <i>X. Gao, D. Mamaluy, E. C. Cyr, M. J. Marinella</i>	49
Memcapacitive Characteristics of Metal-Oxide-Semiconductor Capacitor Structures by Compositional Redistribution <i>P. Yang, Y. J. Noh, Y. J. Baek, H. Zheng, C. J. Kang, T. S. Yoon</i>	59
Metal Oxide Thin Film Characterization for New Generation Chemical Mechanical Planarization Development <i>G. B. Basim, A. Karagoz</i>	67
Influence of Doping and Tunneling Interface Stoichiometry on $n+\text{In}_{0.5}\text{Ga}_{0.5}\text{As}/p+\text{GaAs}_{0.5}\text{Sb}_{0.5}$ Esaki Diode Behavior <i>S. El Kazzi, A. Alireza, C. C. M. Bordallo, Q. Smets, L. Desplanque, X. Wallart, O. Richard, B. Douhard, A. Verhulst, N. Collaert, C. Merckling, M. Heyns, A. Thean</i>	73

Chapter 4 Connectivity Devices, Processes and Issues

(Invited) Near-Field Coupling Integration Technology <i>T. Kuroda</i>	83
(Invited) Beyond-CMOS Device and Interconnect Technology Benchmarking Based on a Fast Cross-Layer Optimization Methodology <i>C. Pan, A. Naeemi</i>	93
(Invited) 300GHz CMOS Wireless Communication with 32 Quadrature-Amplitude-Modulation Capability <i>M. Fujishima</i>	105

(Invited) Hardware Security to Mitigate Threats to Networked More-Than-Moore Sensors <i>Y. S. Obeng</i>	113
Author Index	119